

HWUSB3B

Introduction

HIVIEW provides a compact usb3 interface board for camera module.

The board converts the native LVDS signal of the camera and transfers the video image to a computer.

You will take advantage of new visualization, processing and image transfer solutions by using the network streaming possibilities.

Features

- Support Sony FCB-EH/EV series and SE600
- LVDS video input from camera
- USB Video Class(UVC)
- USB Communication Device Class(CDC)
- > Automatics Sony camera module recognition
- Up to 1080p@60fps video out
- Board and camera module management by micro switch
- Power supply 5V for SE600,12V(external)
- ➤ Tiny module size 48mm x 48mm x11mm, mounting hole 34mm x 34mm

Specification

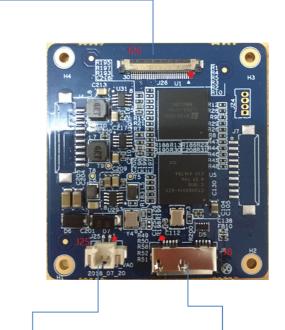
Video Input	Interface	LVDS/BT1120		
		1920X1080/60fps 1920X1080/50fps		
	Frame rate	1920X1080/30fps 1920X1080/25fps		
		1280X720/60fps 1280X720/50fps		
		1280X720/30fps 1280X720/25fps		
Video Encode	USB	USB3.0		
	Video Format	YUV 422		
	Frame Rate	up to 1080P/60Hz		
USB parameter	USB Standard	USB3.0 / USB2.0		
	USB UVC Class	Support		
	USB CDC protocol	Support		
	Camera setting and control	USB3.0-UVC V1.1-CDC V1.1		
		(VCP embedded RS232 channel)		
Other	Operating temperature /humidity	-20°era C ~ 55°C/0%-90%		
	Power supply	Self-powered by USB3.0 or 12VDC		
	Power consumption (max)	<1.5W		
	Dimensions(mm)	L(48mm)*W(48mm)*H(11mm)		
	Weight/PCS(g)	40g		
	Operating temperature /humidity	-20°C ~ 55°C/0%-90%		





Interface

J26:LVDS		(30Pin USL20-30SS-005-C)		
No.	Name	No.	Name	
1	NC	16	12V	
2	NC	17	12V	
3	NC	18	RXD1	
4	NC	19	TXD1	
5	NC	20	GND	
6	NC	21	TXIN0-	
7	GND	22	TXIN0+	
8	GND	23	TXIN1-	
9	GND	24	TXIN1+	
10	GND	25	TXIN2-	
11	GND	26	TXIN2+	
12	GND	27	TXCLK-	
13	12V	28	TXCLK+	
14	12V	29	TXIN3-	
15	12V	30	TXIN3+	



J25: 2Pin		J8:10Pin Micro USB3.0	
No.	Name	No.	Name
1	GND	1	VBUS
2	12V	2	D-
		3	D+
		4	ID
		5	GND
		6	MICRO_SSTX-
		7	MICRO_SSTX+-
		8	GND
		9	MICRO_SSRX-
		10	MICRO_SSRX+